

Taiwan Semiconductor

5000W, 16V - 100V Surface Mount Transient Voltage Suppressor

FEATURES

- 5000 watts peak pulse power capability at 10/1000µs waveform
- Ideal for automated placement
- Glass passivated junction
- Excellent clamping capability
- Fast response time: Typically less than 1.0ps
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- I/O interface
- AC/DC power supply
- Automotive

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.30g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
V _{WM}	16 - 100	V			
V _{BR} (uni-directional)	17.8 - 123	V			
P _{PPSM}	5000	W			
T _{J MAX}	175	°C			
Package	DO-214AB (SMC)				
Configuration	Single die				



DO-214AB (SMC)

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)						
PARAMETER	SYMBOL	VALUE	UNIT			
Non-repetitive peak impulse power dissipation with 10/1000us waveform ⁽¹⁾	P _{PPSM}	5000	W			
Steady state power dissipation at T_L =75°C ⁽²⁾	P _{tot}	6.25	W			
Forward Voltage @ I _F =100A for Uni-directional only ⁽³⁾	V _F	5	V			
Junction temperature	TJ	-55 to +175	°C			
Storage temperature	T _{STG}	-55 to +175	°C			

- Notes:
- 1. Non-repetitive Current Pulse Per Fig. 3 and derated above TA=25°C Per Fig. 1
- 2. Units mounted on recommended PCB (16mm x 16mm Cu pad test board)
- 3. Pulse test with PW=0.3 ms

THERMAL PERFORMANCE							
PARAMETER	SYMBOL	LIMIT	UNIT				
Junction-to-lead thermal resistance per diode	$R_{\Theta JL}$	16	°C/W				
Junction-to-ambient thermal resistance per diode	R _{eja}	61	°C/W				
Junction-to-case thermal resistance per diode	R _{eJC}	17	°C/W				

Thermal Performance Note: Units mounted on recommended PCB (16mm x 16mm Cu pad test board)



ORDERING INFORMATION							
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING		
5.0SMDJxxA (Note 1, 2)	н	R7	G	SMC	850 / 7" Plastic reel		
		R6			3,000 / 13" Paper reel		
		M6			3,000 / 13" Plastic reel		

Notes :

1. "xx" defines voltage from 16V (5.0SMDJ16A) to 100V (5.0SMDJ100A)

2. Whole series with green compound (halogen-free)

EXAMPLE						
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION	
5.0SMDJ16AHR7G	5.0SMDJ16A	Н	R7	G	AEC-Q101 qualified Green compound	



5.0SMDJ16A - 5.0SMDJ100A Taiwan Semiconductor

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)									
Part number	Marking code	Break volta V _{BR} ((V (Note	down age @I _T ') e 1)	Test current I _T (mA)	Working stand- off voltage V _{WM}	Maximum blocking leakage current I _{IB} @V _{WM} (⊔∆)	Maximum peak impulse current I _{PP}	Maximum clamping voltage V _C @I _{PP} (V)	Maximum Temp. coefficient of V _{BR} αV _{BR} @I _T
Uni	Uni	Min.	Max.		(V)	(Note 1)	(A)	(-)	(mV/°C)
5.0SMDJ16A	5PET	17.8	19.7	1	16	50	193	26.0	0.096
5.0SMDJ17A	5PEU	18.9	20.9	1	17	20	181	27.6	0.097
5.0SMDJ18A	5PEV	20.0	22.1	1	18	10	172	29.2	0.098
5.0SMDJ20A	5PEW	22.2	24.5	1	20	5	155	32.4	0.099
5.0SMDJ22A	5PEX	24.4	26.9	1	22	5	141	35.5	0.100
5.0SMDJ24A	5PEZ	26.7	29.5	1	24	2	129	38.9	0.101
5.0SMDJ26A	5PFE	28.9	31.9	1	26	2	119	42.1	0.101
5.0SMDJ28A	5PFG	31.1	34.4	1	28	2	110	45.4	0.102
5.0SMDJ30A	5PFK	33.3	36.8	1	30	2	103	48.4	0.103
5.0SMDJ33A	5PFM	36.7	40.6	1	33	2	93.9	53.3	0.104
5.0SMDJ36A	5PFP	40.0	44.2	1	36	2	86.1	58.1	0.104
5.0SMDJ40A	5PFR	44.4	49.1	1	40	2	77.6	64.5	0.105
5.0SMDJ43A	5PFT	47.8	52.8	1	43	2	72.1	69.4	0.105
5.0SMDJ45A	5PFV	50.0	55.3	1	45	2	68.8	72.7	0.106
5.0SMDJ48A	5PFX	53.3	58.9	1	48	2	64.7	77.4	0.106
5.0SMDJ51A	5PFZ	56.7	62.7	1	51	2	60.7	82.4	0.107
5.0SMDJ54A	5PGE	60.0	66.3	1	54	2	57.5	87.1	0.107
5.0SMDJ58A	5PGG	64.4	71.2	1	58	2	53.5	93.6	0.107
5.0SMDJ60A	5PGK	66.7	73.7	1	60	2	51.7	96.8	0.108
5.0SMDJ64A	5PGM	71.1	78.6	1	64	2	48.6	103	0.108
5.0SMDJ70A	5PGP	77.8	86.0	1	70	2	44.3	113	0.108
5.0SMDJ75A	5PGR	83.3	92.1	1	75	2	41.4	121	0.108
5.0SMDJ78A	5PGT	86.7	95.8	1	78	2	39.7	126	0.108
5.0SMDJ85A	5PGV	94.4	104	1	85	2	36.5	137	0.110
5.0SMDJ90A	5PGX	100	111	1	90	2	34.3	146	0.110
5.0SMDJ100A	5PGZ	111	123	1	100	2	30.9	162	0.110

Note:

1. Pulse test with PW=30 ms



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CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Pulse Power or Current vs. Initial Junction



Fig.3 Pulse Waveform

6.5 6.0 5.5 5.0 4.5 4.0 3.5 3.0 2.5 2.0 1.5 Heat sink 1.0 16mm x 16mm 0.5 Cu pad test board 0.0 0 25 50 75 100 125 150 175 LEAD TEMPERATURE (°C)

Fig.2 Power Derating Curve

Fig.4 Typical Junction Capacitance





5.0SMDJ16A - 5.0SMDJ100A

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PACKAGE OUTLINE DIMENSIONS



Un		(mm)	Unit (inch)		
DIN.	Min	Max	Min	Max	
А	2.90	3.20	0.114	0.126	
В	6.60	7.11	0.260	0.280	
С	5.59	6.22	0.220	0.245	
D	2.00	2.62	0.079	0.103	
E	1.00	1.60	0.039	0.063	
F	7.75	8.13	0.305	0.320	
G	0.10	0.20	0.004	0.008	
Н	0.15	0.31	0.006	0.012	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	3.30	0.130
В	2.50	0.098
С	6.80	0.268
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM



- G =Green compound
- YW = Date Code
- F = Factory Code



5.0SMDJ16A - 5.0SMDJ100A

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